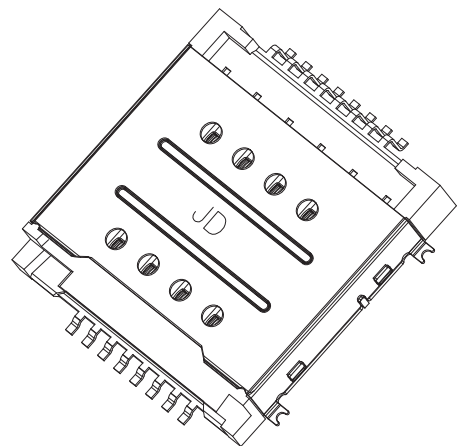
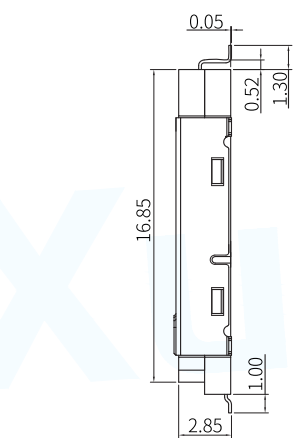
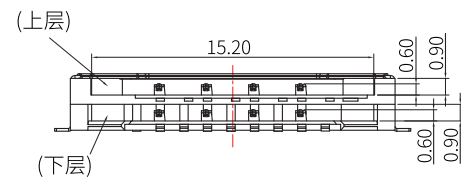
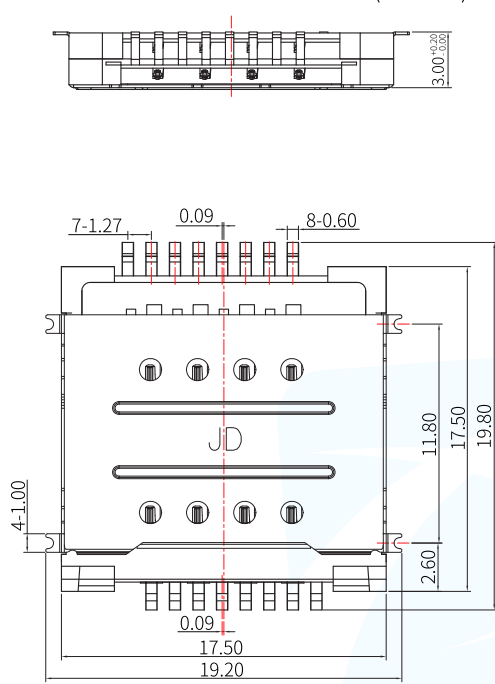
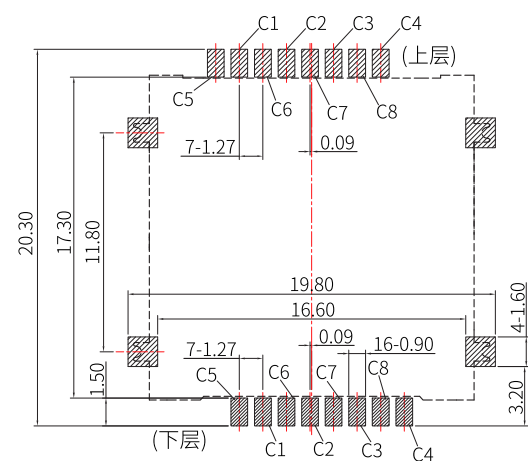
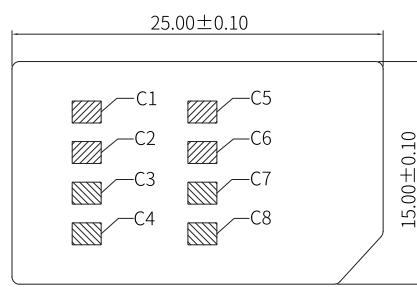


双层 SIM CARD CONNECTOR(短上层)



MicroSIM CARD	
Pin No.	NAME
C1	VCC(供电电压)
C2	RST(时钟)
C3	CLK(重置)
C4	Reserved
C5	GND(接地)
C6	VPP(程序电压)
C7	I/O(输入输出)
C8	Reserved



Recommended P.C.B Layout(Tolerance=±0.05)  
AS VIEW FORM COMPONENT SIDE

NOTES:

- 1.MATERIAL  
HOUSING:THERMOPLASTIC,UL94V-0;COLOR:BLACK  
CONTACT:COPPER ALLOY  
SHELL:STAINLESS STEEL
- 2.FINISH  
CONTACT:NICKEL UNDERPLANED AND GOLD PLANTING  
OVER ALL:  
OR NICKEL UNDERPLANED AND GOLD PLANTING  
ON CONTACT AREA;TIM PLANTING ON SOLDER AREA  
SHELL:NICKEL UNDERPLANED AND GOLD PLANTING ON SOLDER AREA

MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd			
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE: 双层SIM CARD		
			PAR	MCS-102JD	
DECIMALS:			DWN	KING	2012.03.08
X:±0.5			CHKD		
ANGLES:		APVD			
X.X:±0.3		SCALE 1:1	UNIT: mm		
X.XX:±0.2		CUSTOMER COPY	SIZE:A4	SHEET:1F1	
			REV:A		